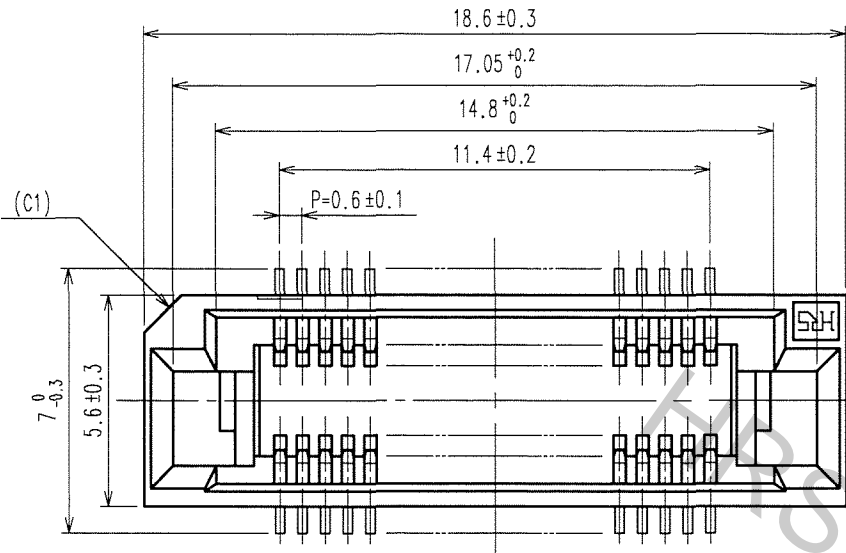
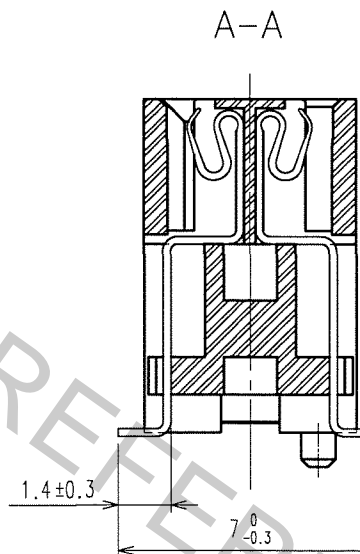
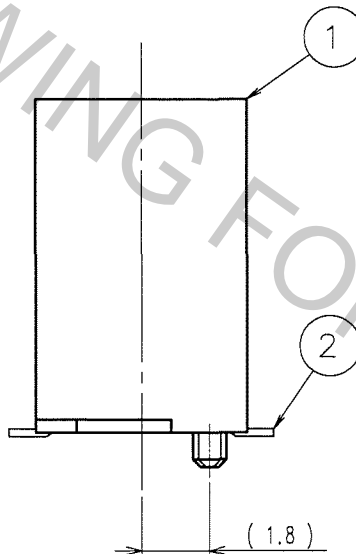
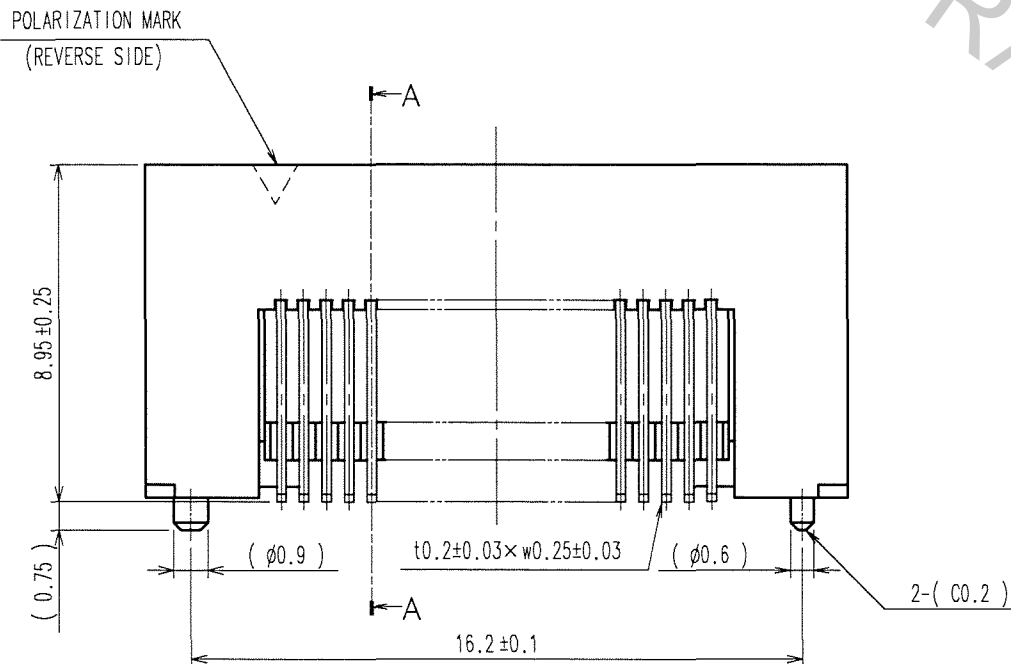
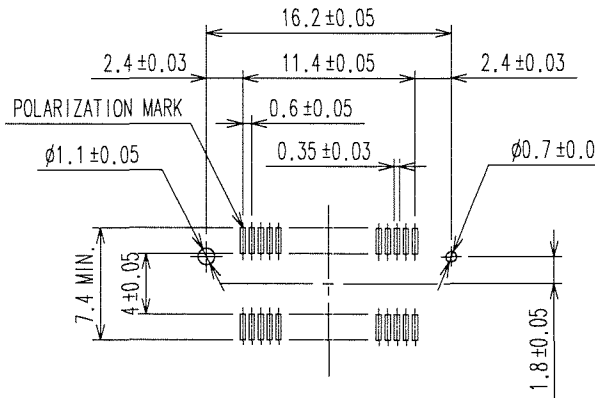


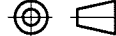

	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△					. .	△					. .
△					. .	△					. .
△					. .	△					. .



RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE) (2:1)



- NOTE 1. LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
2. FOR MODIFICATION,ETC.,PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES
3. THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

1,3 PPS		LIGHT BROWN (UL94V-0)		2 PHOSPHOR BRONZE		CONTACT AREA:GOLD 0.1μm min.								
						LEAD AREA:TIN-PLATING 1μm min.								
						UNDER PLATING:NICKEL 1μm min.								
NO.		MATERIAL		FINISH, REMARKS		NO.		MATERIAL		FINISH, REMARKS				
CODE NO. (OLD) CL					DRAWN		DESIGNED		CHECKED		APPROVED		RELEASED	
					S.KAMIGA 07.04.19		S.KAMIGA 07.04.19		H. Ogawa 07.04.19		H. Ogawa 07.04.19		. .	
		DRAWING NO.						PART NO.						
		EDC3-151170-25						FX8C-40S-SV5(71)						
		 HIROSE ELECTRIC CO., LTD						CODE NO.						
CL578-0829-1-71								1/1						

TO
PCK